

# ST75C176

### Low power RS-485/RS-422 transceiver

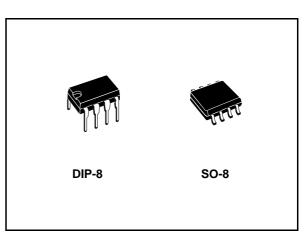
### **General features**

- Low quiescent current: 300mA
- Designed for RS-485 interface applications
- -7V to 12V common mode input voltage range
- Driver maintains high impedance in 3-state or with the power OFF
- 70mV typical input hysteresis
- 30ns propagation delays, 5ns skew
- Operate from a single 5V supply
- Current limiting and thermal shutdown for driver overload protection
- Allows up to 32 transceivers on the bus
- Bic mos technology

### Description

The ST75C176 is al low power transceiver for RS-485 and RS-422 communication. Each part contains one driver and one receiver.

This transceiver draw 300mA (typ.) of supply current when unloaded or fully loaded with disabled drivers.



It operates from a single 5V supply.

Driver is short-circuit current limited and is protected against excessive power dissipation by thermal shutdown circuitry that placed the driver outputs into a high-impedance state. The receiver input has a fail safe feature that guarantees a logic-high output if the input is open circuit.

The ST75C176 is designed for bi-directional data communications on multipoint bus transmission line (half-duplex applications).

### **Order code**

Part number	Temperature range	Package	Packaging
ST75C176CN	0 to 70 °C	DIP-8	50parts per tube / 40tube per box
ST75C176BN	-40 to 85 °C	DIP-8	50parts per tube / 40tube per box
ST75C176CDR	0 to 70 °C	SO-8 (Tape & Reel)	2500 parts per reel
ST75C176BDR	-40 to 85 °C	SO-8 (Tape & Reel)	2500 parts per reel

May 2006

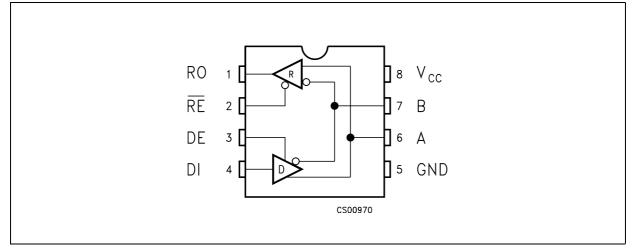
### Contents

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# 1 Pin configuration

#### Figure 1. Pin connections



### Table 1. Pin description

Pin n°	Symbol	Name and function
1	RO	Receiver output
2	RE	Receiver output enable
3	DE	Driver output enable
4	DI	Driver input
5	GND	Ground
6	А	Non-inverting receiver input and non-inverting driver output
7	В	Inverting receiver input and inverting driver output
8	V <sub>CC</sub>	Supply voltage



## 2 Truth tables

#### Table 2.Truth table (driver)

	Inputs			puts
RE	DE	DI	В	A
X	Н	Н	L	н
Х	Н	L	Н	L
X	L	Х	Z	Z

Note: X= Don't care; Z=High impedance

### Table 3.Truth table (receiver)

	Inputs		Output
RE	DE	A-B	RO
L	L	≥ +0.2V	Н
L	L	≤ -0.2V	L
L	L	INPUTS OPEN	Н
Н	L	Х	Z

Note: X= Don't care; Z=High impedance



## 3 Maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage	7	V
VI	Control input voltage (RE, DE)	-0.5 to (V <sub>CC</sub> + 0.5)	V
V <sub>DI</sub>	Driver input voltage (DI)	-0.5 to (V <sub>CC</sub> + 0.5)	V
V <sub>DO</sub>	Driver output voltage (A, B)	± 14	V
V <sub>RI</sub>	Receiver input voltage (A, B)	± 14	V
V <sub>RO</sub>	Receiver output voltage (RO)	-0.5 to (V <sub>CC</sub> + 0.5)	V

#### Table 4. Absolute maximum ratings

Note: Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.



## 4 Electrical characteristics

#### Table 5. DC electrical characteristics

(V<sub>CC</sub> = 5V ± 5%, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise specified. Typical values are referred to T<sub>A</sub> = 25°C) (See *Note 1*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>OD1</sub>	Differential driver output (no load)				5	V
V <sub>OD2</sub>	Differential driver output (with load)	$R_L = 27\Omega$ (RS-485), (See <i>Figure 2.</i> ) $R_L = 50\Omega$ (RS-422), (See <i>Figure 2.</i> )	1.5		5 5	V V
$\Delta V_{OD}$	Change in magnitude of driver differential output voltage for complementary output states	$R_L = 27\Omega$ or 50Ω (See <i>Figure 2.</i> )			0.2	V
V <sub>OC</sub>	Driver common-mode output voltage	$R_L = 27\Omega$ or 50Ω (See <i>Figure 2.</i> )			3	V
ΔV <sub>OC</sub>	Change in magnitude of driver common-mode output voltage for complementary output states	$R_L = 27\Omega$ or 50Ω (See <i>Figure 2.</i> )			0.2	V
V <sub>IH</sub>	Input high voltage	RE, DE, DI	2.0			V
V <sub>IL</sub>	Input low voltage	RE, DE, DI			0.8	V
I <sub>IN1</sub>	Input current	RE, DE, DI			±2	μΑ
I <sub>IN2</sub>	Input current (A, B)	$V_{CM} = 0V \text{ or } 5.25V, V_{DE} = 0V$ $V_{IN} = 12V$ $V_{IN} = -7V$			1 -0.8	mA mA
$V_{TH}$	Receiver differential threshold voltage	V <sub>CM</sub> = -7 to 12V	-0.2		0.2	V
$\Delta V_{TH}$	Receiver input hysteresis	$V_{CM} = 0V$		70		mV
V <sub>OH</sub>	Receiver output high voltage	I <sub>O</sub> = -4mA, V <sub>ID</sub> = 200mV	3.5			V
V <sub>OL</sub>	Receiver output low voltage	I <sub>O</sub> = 4mA, V <sub>ID</sub> = -200mV			0.4	V
I <sub>OZR</sub>	3-State (high impedance) output current at receiver	$V_{O} = 0.4 \text{ to } 2.4 \text{V}$			± 1	μΑ
R <sub>IN</sub>	Receiver input resistance	V <sub>CM</sub> = -7 to 12V	12			KW
I <sub>CC</sub>	No load supply current ( <i>Note 2</i> )	$V_{RE} = 0V \text{ or } V_{CC}$ $V_{DE} = V_{CC}$ $V_{DE} = 0V$		400 300	900 500	μΑ μΑ
I <sub>OSD1</sub>	Driver short-circuit current, V <sub>O</sub> =High	V <sub>O</sub> = -7 to 12V ( <i>Note 3</i> )	35		250	mA



#### Table 5.DC electrical characteristics

(V<sub>CC</sub> = 5V ± 5%, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise specified. Typical values are referred to T<sub>A</sub> = 25°C) (See *Note* 1)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>OSD2</sub>	Driver short-circuit current, $V_O$ =Low	V <sub>O</sub> = -7 to 12V ( <i>Note 3</i> )	35		250	mA
I <sub>OSR</sub>	Receiver short-circuit current	$V_{O} = 0V$ to $V_{CC}$	7		95	mA

1 All currents into device pins are positive; all cuts out of device pins are negative; all voltages are referenced to device ground unless specified.

- 2 Supply current specification is valid for loaded transmitters when  $V_{DE} = 0V$
- 3 Applies to peak current. See typical operating characteristics.

#### Table 6. Driver switching characteristics

(V<sub>CC</sub> = 5V ± 5%,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise specified. Typical values are referred to  $T_A = 25^{\circ}$ C) (See Note 1)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay input to output	$R_{DIFF} = 54\Omega$ , $C_{L1} = C_{L2} = 100pF$ (See <i>Figure 4</i> and <i>Figure 6</i> )	10	30	60	ns
t <sub>SK</sub>	Output skew to output	$R_{DIFF} = 54\Omega$ , $C_{L1} = C_{L2} = 100pF$ (See <i>Figure 4</i> and <i>Figure 6</i> )		5	10	ns
t <sub>TLH</sub> t <sub>THL</sub>	Rise or fall time	$R_{DIFF} = 54\Omega$ , $C_{L1} = C_{L2} = 100pF$ (See <i>Figure 4</i> and <i>Figure 6</i> )	3	15	40	ns
t <sub>PZH</sub>	Output enable time	C <sub>L</sub> = 100pF, S2 = Closed (See <i>Figure 5</i> and <i>Figure 7</i> )		40	70	ns
t <sub>PZL</sub>	Output enable time	C <sub>L</sub> = 100pF, S1 = Closed (See <i>Figure 5</i> and <i>Figure 7</i> )		40	70	ns
t <sub>PLZ</sub>	Output disable time	C <sub>L</sub> = 15pF, S1 = Closed (See <i>Figure 5</i> and <i>Figure 7</i> )		40	70	ns
t <sub>PHZ</sub>	Output disable time	C <sub>L</sub> = 15pF, S2 = Closed (See <i>Figure 5</i> and <i>Figure 7</i> )		40	70	ns

Note: 1 All currents into device pins are positive; all cuts out of device pins are negative; all voltages are referenced to device ground unless specified.



#### Table 7. Receiver switching characteristics

(V<sub>CC</sub> = 5V ± 5%, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise specified. Typical values are referred to T<sub>A</sub> = 25°C) (See Note 1)

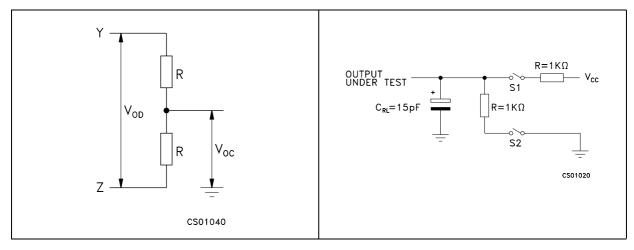
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay input to output	$R_{DIFF} = 54\Omega$ , $C_{L1} = C_{L2} = 100pF$ (See <i>Figure 4</i> and <i>Figure 8</i> )	20	130	210	ns
t <sub>SKD</sub>	Differential receiver skew	$R_{DIFF} = 54\Omega$ , $C_{L1} = C_{L2} = 100pF$ (See <i>Figure 4</i> and <i>Figure 8</i> )		13		ns
t <sub>PZH</sub>	Output enable time	C <sub>RL</sub> = 15pF, S1 = Closed (See <i>Figure 3</i> and <i>Figure 9</i> )		20	50	ns
t <sub>PZL</sub>	Output enable time	C <sub>RL</sub> = 15pF, S2 = Closed (See <i>Figure 3</i> and <i>Figure 9</i> )		20	50	ns
t <sub>PLZ</sub>	Output disable time	C <sub>RL</sub> = 15pF, S1 = Closed (See <i>Figure 3</i> and <i>Figure 9</i> )		20	50	ns
t <sub>PHZ</sub>	Output disable time	C <sub>RL</sub> = 15pF, S2 = Closed (See <i>Figure 3</i> and <i>Figure 9</i> )		20	50	ns
f <sub>MAX</sub>	Maximum data rate		2.5			Mbps

Note: All currents into device pins are positive; all cuts out of device pins are negative; all voltages are referenced to device ground unless specified.



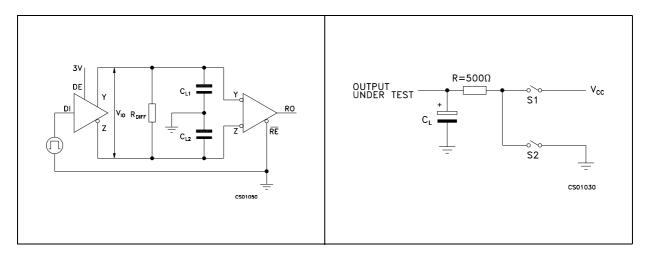
## 5 Test circuits and typical characteristics

#### Figure 2. Driver DC test load



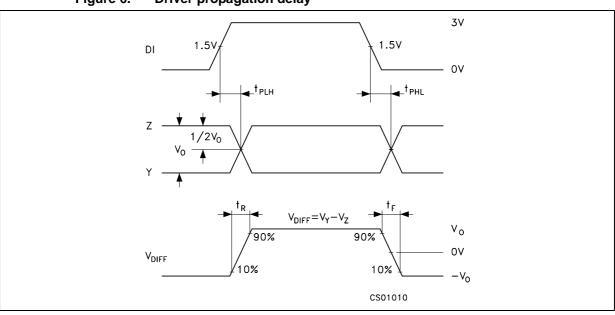


#### Figure 5. Driver timing test load

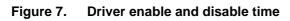


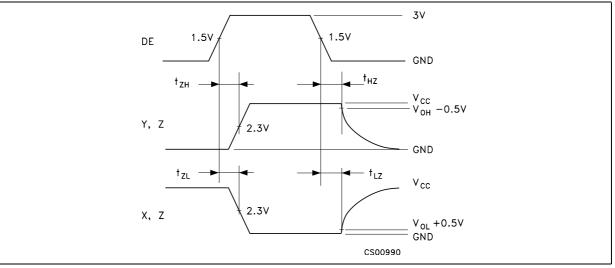
57

### Figure 3. Receiver timing test load



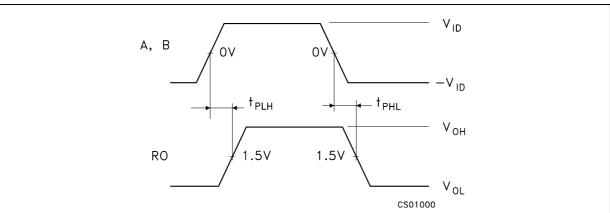
#### Figure 6. Driver propagation delay

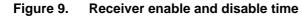


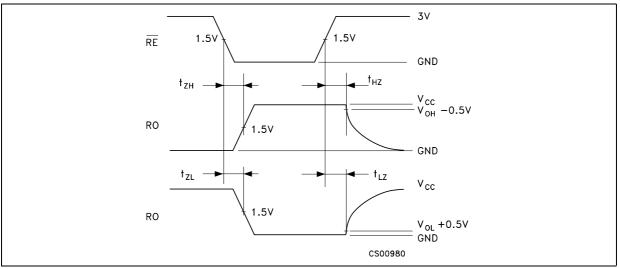


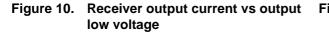


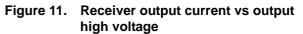


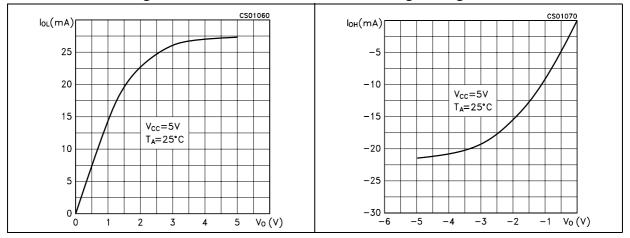












120

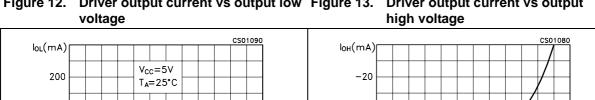
80

40

0

0

1



-40

-60

-80

-100

-120

, -6

-5

#### Driver output current vs output low Figure 13. Figure 12. Driver output current vs output



2

3

4

5

 $V_{OL}(V)$ 

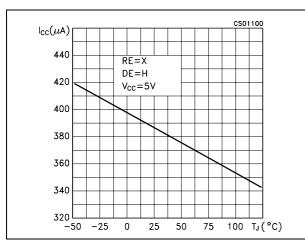


Figure 16. Receiver low level output voltage vs. temperature

Figure 15. Receiver high level output voltage vs. temperature

-3

-2

-1

 $V_0(V)$ 

-4

 $V_{cc}=5V$ T<sub>A</sub>=25°C

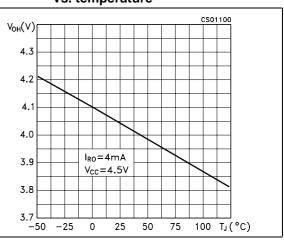
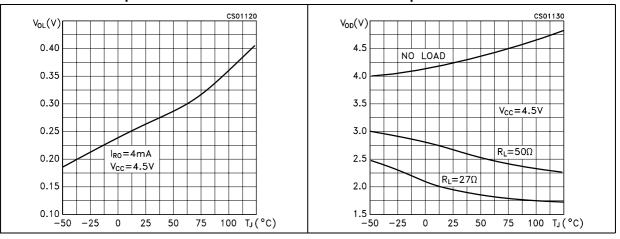


Figure 17. Differential driver output voltage vs temperature



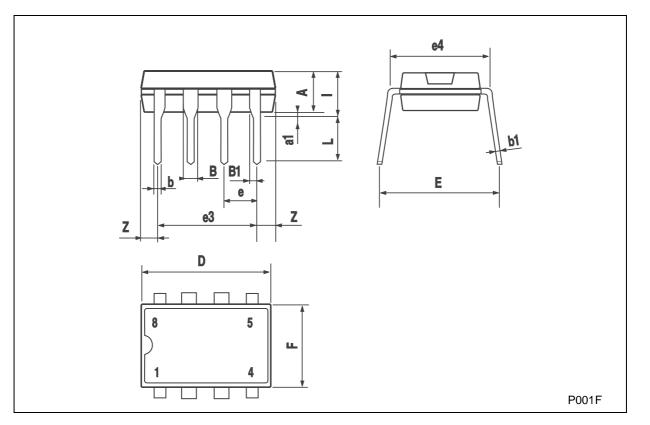
### 6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



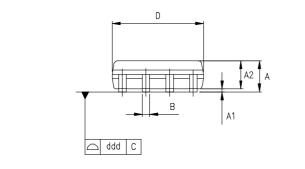
DIM.		mm.			inch	
	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А		3.3			0.130	
a1	0.7			0.028		
В	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
е		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	





DIM		mm.		inch		
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
В	0.33		0.51	0.013		0.020
С	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
е		1.27			0.050	
н	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k		8° (max.)				
ddd			0.1			0.04





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4

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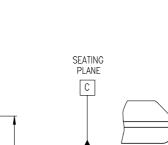
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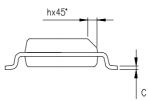
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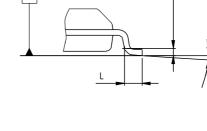
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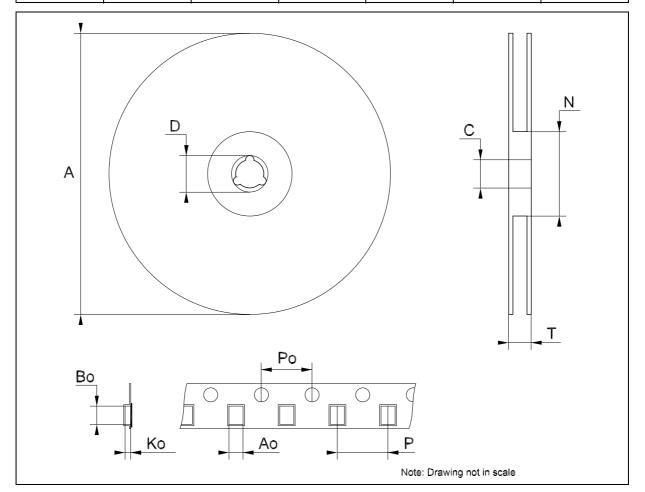


0,25 mm GAGE PLANE

0016023/C



Tape & Reel SO-8 MECHANICAL DATA							
DIM.	mm.			inch			
	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.	
А			330			12.992	
С	12.8		13.2	0.504		0.519	
D	20.2			0.795			
Ν	60			2.362			
Т			22.4			0.882	
Ao	8.1		8.5	0.319		0.335	
Во	5.5		5.9	0.216		0.232	
Ko	2.1		2.3	0.082		0.090	
Po	3.9		4.1	0.153		0.161	
Р	7.9		8.1	0.311		0.319	





# 7 Revision history

#### Table 8.Revision history

Date	Revision	Changes
04-May-2006	3	Order codes has been updated and new template.



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